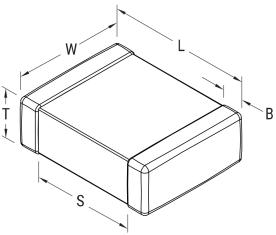


## CHA08X225K9RXL7189

SMD HRA X7R, Ceramic, 2.2 uF, 10%, 6.3 VDC, X7R, High Reliability Alternative (HRA), X-LEVEL, Flex Termination, SnPb, 0805



Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	1.25mm +/-0.15mm
S	0.75mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications	,
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

General Information	
Series	SMD HRA X7R
Style	SMD Chip
Description	High Reliability Alternative (HRA), X-LEVEL, Flex Termination, SnPb
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
Termination	Flexible Termination With Lead (SnPb)
Marking	No
AEC-Q200	No
Typical Component Weight	21 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	2.2 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	6.3 VDC
Dielectric Withstanding Voltage	15.75 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	227.3 MOhms

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